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	Application No.	Applicant(s)	
	10/722,204	AMLESHI ET AL.	
Notice of Allowability	Examiner	Art Unit	
	PHAN T.H. PALMER	2874	
The MAILING DATE of this communication ap All claims being allowable, PROSECUTION ON THE MERITS I herewith (or previously mailed), a Notice of Allowance (PTOL-8 NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT of the Office or upon petition by the applicant. See 37 CFR 1.3	IS (OR REMAINS) CLOSED in t 35) or other appropriate commun RIGHTS. This application is su	his application. If not included ication will be mailed in due co	urse. THIS
1. This communication is responsive to <u>01/03/2005</u> .	•		
2. The allowed claim(s) is/are 17-32.			
3. The drawings filed on are accepted by the Examin	ner.		
4. Acknowledgment is made of a claim for foreign priority  a) All b) Some* c) None of the:  1. Certified copies of the priority documents hat  2. Certified copies of the priority documents hat  3. Copies of the certified copies of the priority of International Bureau (PCT Rule 17.2(a)).  * Certified copies not received:  Applicant has THREE MONTHS FROM THE "MAILING DATE noted below. Failure to timely comply will result in ABANDON THIS THREE-MONTH PERIOD IS NOT EXTENDABLE.	ave been received.  ave been received in Application documents have been received  E" of this communication to file a	Noin this national stage application	
5. A SUBSTITUTE OATH OR DECLARATION must be sub INFORMAL PATENT APPLICATION (PTO-152) which g	omitted. Note the attached EXAN ives reason(s) why the oath or o	INER'S AMENDMENT or NOT declaration is deficient.	TICE OF
6.  ☐ CORRECTED DRAWINGS ( as "replacement sheets") m (a) ☐ including changes required by the Notice of Draftspe 1) ☐ hereto or 2) ☐ to Paper No./Mail Date (b) ☐ including changes required by the attached Examine Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR each sheet. Replacement sheet(s) should be labeled as such in	erson's Patent Drawing Review of the comment or in the case of the	n the Office action of  drawings in the front (not the ba	ack) of
<ol> <li>DEPOSIT OF and/or INFORMATION about the department attached Examiner's comment regarding REQUIREMEN</li> </ol>			e the
<ul> <li>Attachment(s)</li> <li>1. ☑ Notice of References Cited (PTO-892)</li> <li>2. ☑ Notice of Draftperson's Patent Drawing Review (PTO-948)</li> <li>3. ☑ Information Disclosure Statements (PTO-1449 or PTO/SE Paper No./Mail Date 10/27/2004)</li> <li>4. ☐ Examiner's Comment Regarding Requirement for Deposit of Biological Material</li> </ul>	3) 6. Interview Sur Paper No./M 3/08), 7. Examiner's A	rmal Patent Application (PTO-1 nmary (PTO-413), lait Date mendment/Comment tatement of Reasons for Allowa  Ann.H. Palma PHAN T. H. PALME PRIMARY EXAMINE  05/22/2005	ance «R

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## **REASONS FOR ALLOWANCE**

1. The following is an examiner's statement of reasons for allowance: the claims are allowable over prior art of record, because none of the references in alone or in combination discloses:

## +++ A method of coupling a laser diode to an optical fiber comprising:

- placing the laser diode on a substrate;
- depositing a polymer layer on at least a part of the substrate between the laser diode and the optical fiber;
  - locating a light emitting area of the laser diode; and
- forming a waveguide on the polymer layer between the light emitting area of the laser diode and the optical fiber, as discloses in claim 17.

## +++ A method of coupling a laser diode to an optical fiber comprising:

- placing a cladding layer on a substrate;
- placing the laser diode on the cladding layer;
- depositing a polymer layer on the laser diode and the cladding layer;
- locating a light emitting area of the laser diode; and
- forming a waveguide on the polymer layer between the light emitting area of the laser diode and the optical fiber, as discloses in claim 31.

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+++ A method of coupling a laser diode to an optical fiber comprising:

- depositing a buffer layer on a substrate;
- depositing a polymer layer on the buffer layer;
- depositing a cladding layer on the polymer layer;
- etching a trench into the layers to a depth such that the laser diode
   placed in the trench would be aligned with a plane of the polymer layer;
  - placing the laser diode in the trench;
  - locating a light emitting area of the laser diode; and
- forming a waveguide the polymer layer between the light emitting area of the laser diode and the optical fiber, as discloses in claim 32.

The underlined steps of the method as discloses in claims 17, 31, and 32 are critically, since the emitting area of a laser diode needs to be accurately aligned with its waveguide facet in order to achieve good coupling efficiency of the laser source, and reduce the time consuming and costly.

The Huignard et al. (4,286,838) reference discloses a compact optical structure comprising a semiconductor emitter junction, a laser or a light emitting diode coupled to a plane waveguide formed by a layer of photo-polymer deposited on a substrate with a suitable index.

The Fern et al. (6,487,354 B1) reference discloses a method for forming a single mode optical waveguide on a substrate.

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Both references do not disclose the method with the underlined steps of claims 17, 31, and 32.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

## **CONTACT INFORMATION**

2. Any inquiry concerning this communication or earlier communications from the examiner should be directed to PHAN T.H. PALMER whose telephone number is (571) 272-2354. The examiner can normally be reached on Monday to Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, RODNEY B. BOVERNICK can be reached on (571) 272-2344. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

PTHP 05/22/2005

PHAN T. H. PALMER PRIMARY EXAMINED